# **Quad Power MOSFET**

# 24 V, 15 A, N-Channel, PInPAK<sup>™</sup> Package

#### **Features**

- Four N-Channel MOSFETs in a Single Package
- High Drain Current (Up to 80A per Device, Single Pulse  $t_p < 10 \mu s$ ,  $R_{\theta JC} = 1.5 \text{ °C/W}$
- High Input Impedance for Ease of Drive
- Ultra Low On-resistance (R<sub>DS(on)</sub>) Provides Low Conduction Losses
- Very Fast Switching Times Provides Low Switching Losses
- Low Parasitic Inductance
- Low Stored Charge for Efficient Switching
- Very Low V<sub>SD</sub> Ideal for Synchronous Rectification
- 200% Footprint Reduction Compared to Similar DPAK Solution for the Same Power
- Advanced Leadless Power Integrated Package (PInPAK)

### Applications

- DC-DC Converters
- Motherboard/Server Voltage Regulator
- Telecomm/Industrial Power Supply
- H-Bridge Circuits
- Low Voltage Motor Control

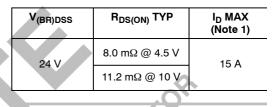
### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Applications <ul> <li>DC-DC Converte</li> <li>Motherboard/Serv</li> <li>Telecomm/Industr</li> <li>H-Bridge Circuits</li> <li>Low Voltage Moto</li> </ul> MAXIMUM RATING	er Voltag ial Powe or Contro	r Supply	5	oted)	15 OUP	BS ON
Parameter		Symbol	Value	Units	$\mathbf{C}$	
Drain-to-Source Voltage			V <sub>DSS</sub>	24	V	
Gate-to-Source Volta			V <sub>GS</sub>	±20	V	
Continuous Drain Current (Note 1)	Steady State	T <sub>A</sub> =25°C	Ι <sub>D</sub>	15	A	
	Olulo	T <sub>A</sub> =85°C	0	10.9		
	t≤10 s	T <sub>A</sub> =25°C	02	18.8		
Power Dissipation (Note 1)	Steady State	T <sub>A</sub> =25°C	PD	2.9	W	
	t≤10 s	45		4.5		
Continuous Drain	Steady	T <sub>A</sub> =25°C	I <sub>D</sub>	11.4	А	
Current (Note 2)	State	T <sub>A</sub> =85°C		8.2		
Power Dissipation (Note 2)		T <sub>A</sub> =25°C	PD	1.7	W	
Pulsed Drain Current	tp=10 μs	tp=10 μs		32	А	OF
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	
Source Current (Body Diode)			۱ <sub>S</sub>	15	А	NT
Single Pulse Drain-to-Source Avalanche Energy $-$ (V <sub>DD</sub> = 25 V, V <sub>G</sub> =10 V, I <sub>PK</sub> =60 A, L=0.1 mH, R <sub>G</sub> = 1.0 k $\Omega$ )		EAS	80	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		



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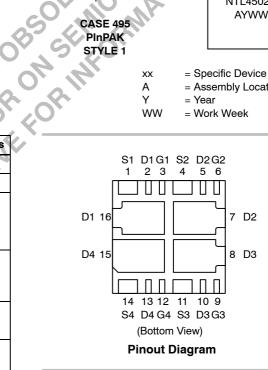


- NTL4502N AYWW
- = Specific Device Code
- = Assembly Location
- = Year WW

xx А

Y





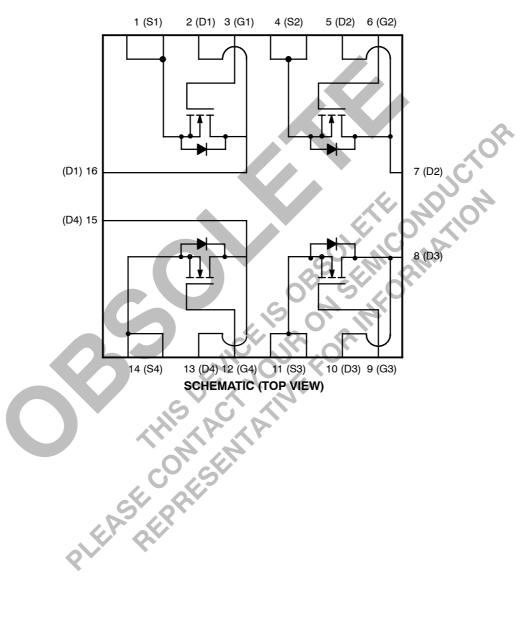
### **ORDERING INFORMATION**

Device	Package	Shipping		
NTL4502NT1	PInPAK	1500 / Reel		

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Units
Junction-to-Case (Drain)	$R_{\thetaJC}$	1.5	°C/W
Junction-to-Ambient – Steady State (Note 1)	$R_{ hetaJA}$	43	
Junction–to–Ambient – t≤10 s (Note 1)	R <sub>θJA</sub>	27.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	75	]

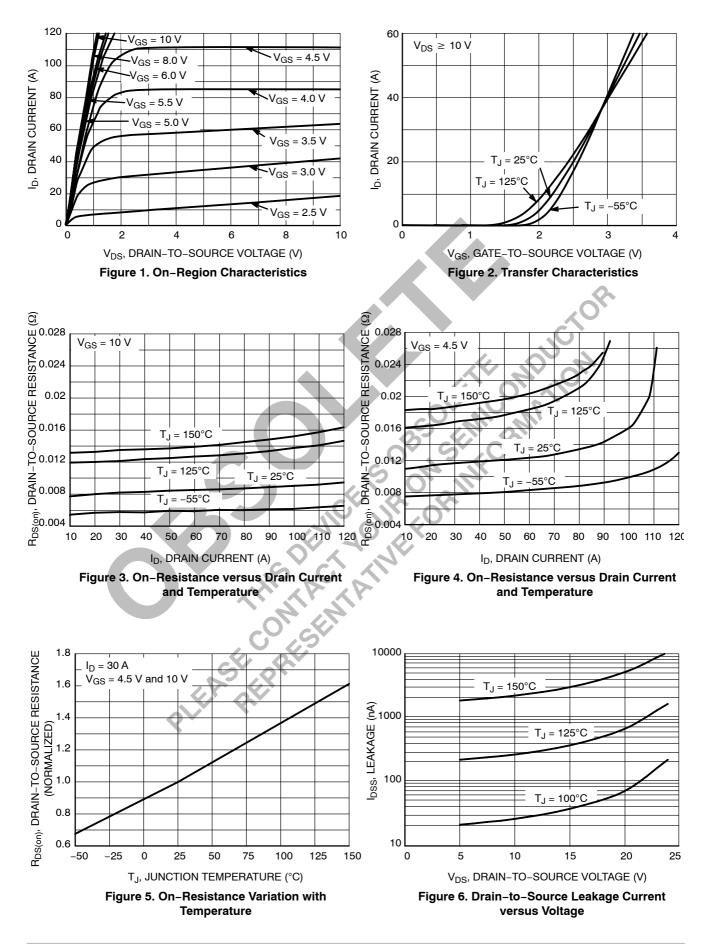
Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
 Surface-mounted on FR4 board using minimum recommended pad size (Cu area = 0.440 in sq).

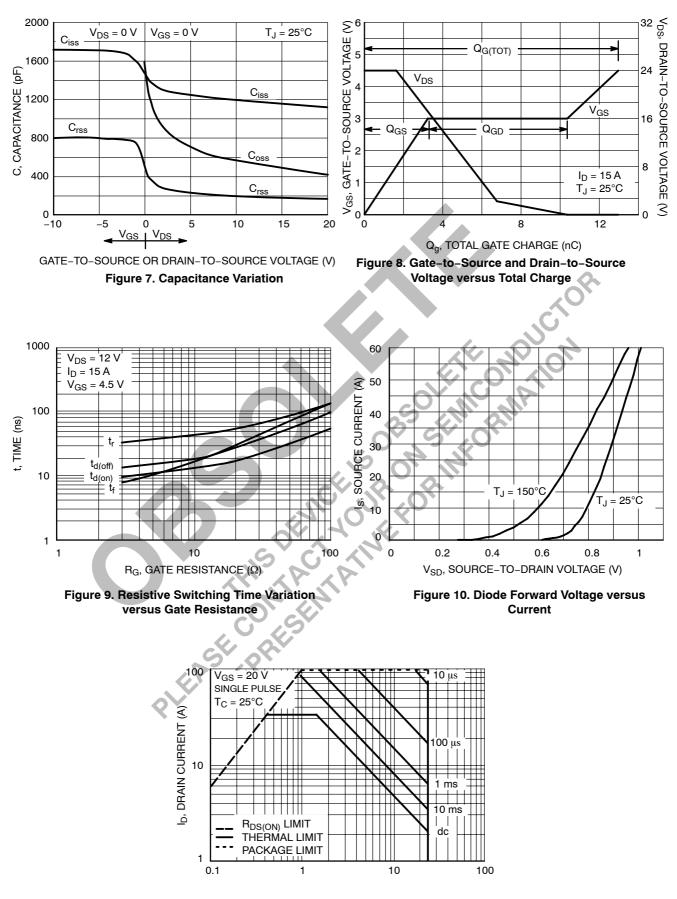


## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		24	27.5		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				25.5		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 V,$	T <sub>J</sub> =25°C			1.5	μΑ
		$V_{GS} = 0 V$	T <sub>J</sub> =125°C			10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20 V, V	<sub>DS</sub> = 0 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D =$	= 250 μA	1.0	1.5	2.0	V
Gate Threshold Voltage Temperature Coefficient	V <sub>GS(th)</sub> /T <sub>J</sub>				-4.1		mV/°C
Drain-to-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A			11.2	13	mΩ
		V <sub>GS</sub> = 10 V, I <sub>E</sub>	= 15 A		8.0	11	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A			27		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>iss</sub>				1070	1605	pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>C</sub> f = 1.0 M	<sub>iS</sub> = 0 V, Hz		408	612	
Reverse Transfer Capacitance	C <sub>rss</sub>				142	213	
Total Gate Charge	Q <sub>G(TOT)</sub>		09	6 0	13		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub>	= 15 A,		1.6		
Gate-to-Source Charge	Q <sub>GS</sub>	$V_{\rm DS} = 24$	V		3.3		-
Gate-to-Drain Charge	Q <sub>GD</sub>			7.0		1	
SWITCHING CHARACTERISTICS, $\boldsymbol{V}_{\boldsymbol{G}}$	s = 10 V (Note	4)					
Turn-On Delay Time	t <sub>d(ON)</sub>	27.70			5.0	8.5	ns
Rise Time	tr	V <sub>GS</sub> = 10 V, V <sub>D</sub>	V <sub>GS</sub> = 10 V, V <sub>DD</sub> = 12 V,		28	47	_
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$I_{\rm D} = 15  {\rm A},  {\rm R}_{\rm G} = 3.0  {\Omega}$			22	37	
Fall Time	t <sub>f</sub>	X  X  X  X			6.0	10	
SWITCHING CHARACTERISTICS, $V_{G}$	<sub>S</sub> = 4.5 V (Note	e 4)					
Turn-On Delay Time	t <sub>d(ON)</sub>	19			9.5	16	ns
Rise Time	t <sub>r</sub>	$V_{GS}$ = 4.5 V, $V_{DD}$ = 12 V, I <sub>D</sub> = 15 A, R <sub>G</sub> = 3.0 Ω			33	55	
Turn-Off Delay Time	t <sub>d(OFF)</sub>				14	23.5	-
Fall Time	t <sub>f</sub>				7.5	12.5	
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 15 A	T <sub>J</sub> =25°C		0.8	1.2	V
			T <sub>J</sub> =125°C		0.7		
Reverse Recovery Time	t <sub>RR</sub>	- V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/μs, I <sub>S</sub> = 15 A			31		ns
Charge Time	t <sub>a</sub>				17		
Discharge Time	t <sub>b</sub>				14		1
Reverse Recovery Charge	Q <sub>RR</sub>				20		nC

4. Switching characteristics are independent of operating junction temperatures.

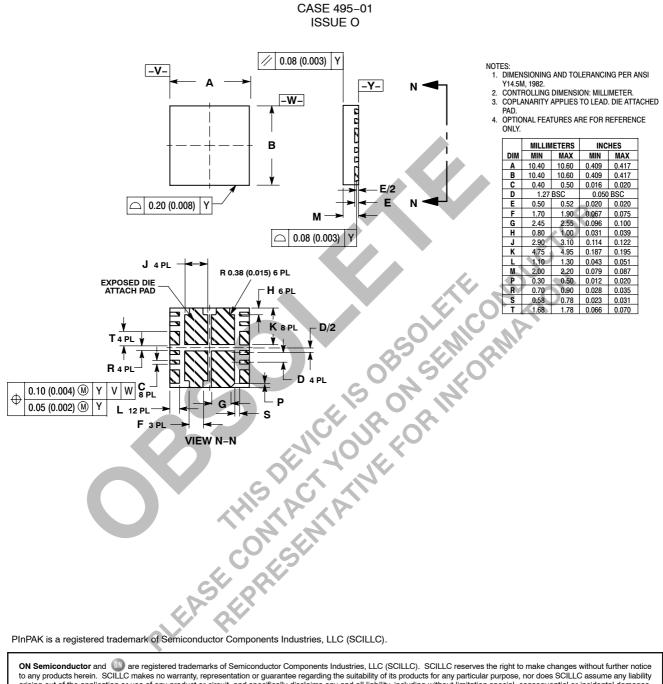






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